















**ESD** 

TVS

MOS

LDO

Diode

Sensor

DC-DC

# **Product Specification**

Domestic Part Number	IRF520N
<ul><li>Overseas Part Number</li></ul>	IRF520N
▶ Equivalent Part Number	IRF520N





## **N-Ch 100V Fast Switching MOSFETs**

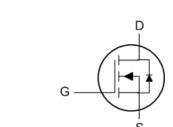
- ★ Super Low Gate Charge
- ★ Green Device Available
- ★ Excellent Cdv/dt effect decline
- ★ Advanced high cell density Trench technology

## **Product Summary**

BVDSS	RDSON	ID
100V	112mΩ	18A

### **TO220 Pin Configuration**





#### **Description**

The IRF520N is the highest performance trench N-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications. The IRF520N meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
V <sub>DS</sub>	Drain-Source Voltage	100	V	
$V_{GS}$	Gate-Source Voltage	±20	V	
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	18	Α	
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	12	Α	
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	40	Α	
EAS	Single Pulse Avalanche Energy <sup>3</sup>	6.1	mJ	
I <sub>AS</sub>	Avalanche Current	11	Α	
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>3</sup>	59	W	
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	

#### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>0JA</sub>	Thermal Resistance Junction-ambient <sup>1</sup>		62	°C/W
ReJC	Thermal Resistance Junction-Case <sup>1</sup>		2.1	°C/W



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#### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V , $I_D$ =250uA	100			V
D-avaus	Static Drain-Source On-Resistance <sup>2</sup>	$V_{GS}=10V$ , $I_{D}=10A$			112	mΩ
Rds(on)		V <sub>GS</sub> =4.5V , I <sub>D</sub> =8A			120	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.0		2.5	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =80V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	uA
IDSS		$V_{DS}$ =80V , $V_{GS}$ =0V , $T_{J}$ =55°C			5	
Igss	Gate-Source Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =10A		13		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		2		Ω
$Q_g$	Total Gate Charge (10V)			26.2		
Qgs	Gate-Source Charge	V <sub>DS</sub> =80V , V <sub>GS</sub> =10V , I <sub>D</sub> =10A		4.6		nC
$Q_{gd}$	Gate-Drain Charge			5.1		1
$T_{d(on)}$	Turn-On Delay Time			4.2		
Tr	Rise Time	$V_{DD}$ =50V , $V_{GS}$ =10V , $R_{G}$ =3.3 $\Omega$ $I_{D}$ =10A		8.2		no
$T_{d(off)}$	Turn-Off Delay Time			35.6		ns
Tf	Fall Time			9.6		
Ciss	Input Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		1535		
Coss	Output Capacitance			60		pF
Crss	Reverse Transfer Capacitance			37		

#### **Diode Characteristics**

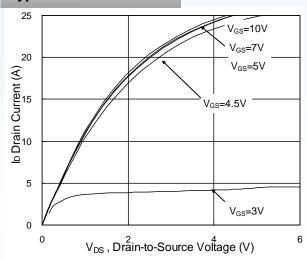
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,5</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			10	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1.2	V
t <sub>rr</sub>	Reverse Recovery Time			37		nS
Qrr	Reverse Recovery Charge	IF=10A , dI/dt=100A/μs , T <sub>J</sub> =25°C		27.3		nC

#### Note:

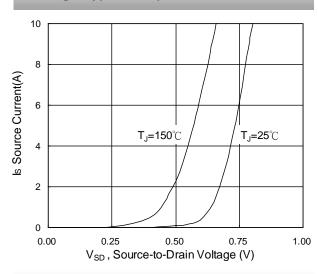
- 1. The data tested by surface mounted on a 1 inch $^2\,\text{FR-4}$  board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%
- 3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =11A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



#### **Typical Characteristics**



#### **Fig.1 Typical Output Characteristics**



#### **Fig.3 Source Drain Forward Characteristics**

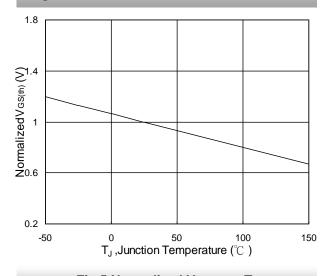


Fig.5 Normalized  $V_{\text{GS(th)}}$  vs  $T_{\text{J}}$ 

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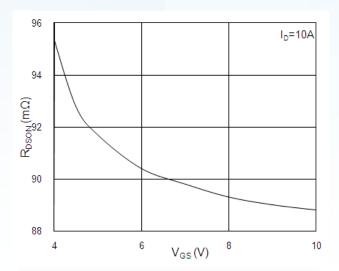


Fig.2 On-Resistance vs G-S Voltage

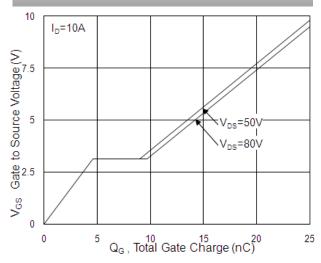


Fig.4 Gate-Charge Characteristics

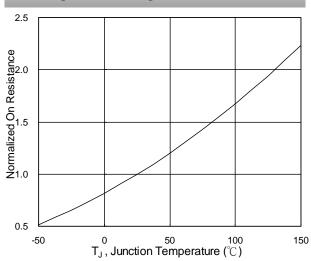
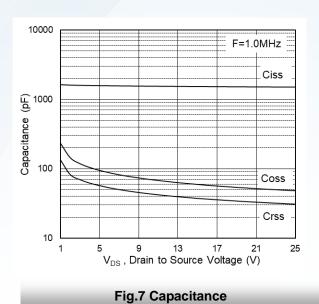


Fig.6 Normalized RDSON vs TJ





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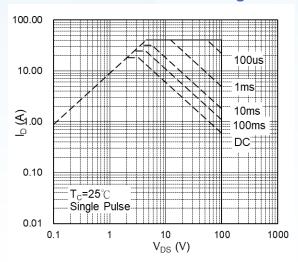
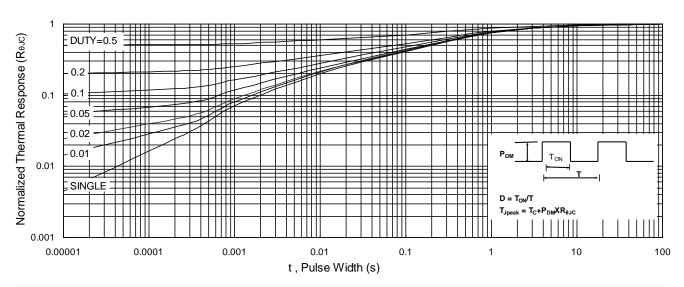


Fig.8 Safe Operating Area



#### Fig.9 Normalized Maximum Transient Thermal Impedance

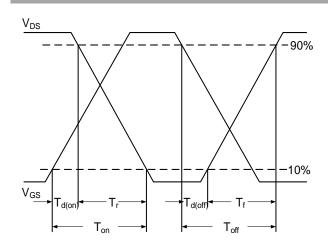


Fig.10 Switching Time Waveform

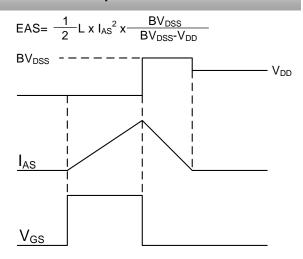


Fig.11 Unclamped Inductive Switching Waveform



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